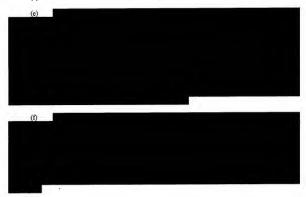
PTO/SB/96 (01-09)
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U.S. Patent and Trademark. Office; U.S. DEPARTMENT OF COMMERCE
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STATEMENT UNDER 37 CFR 3.73(b)						
Applicant/Patent Owner: Aptina Imaging Corporation						
	Filed/Issue Date: February 21, 2006					
Titled: ANALOG TO DIGITAL CONVERTER WITH INTE						
THEEL. ANALOG TO DIGITAL CONVERTER WITH INTE						
Aptina Imaging Corporation , a (Type of As	Corporation signee, e.g., corporation, partnership, university, government agency, etc.)					
	signos, e.g., corporation, particularly, currously, government agency, every					
states that it is:						
the assignee of the entire right, title, and interest in;						
2. an assignee of less than the entire right, title, and interest	in					
(The extent (by percentage) of its ownership interest is	s %); or					
3. an assignee of an undivided interest in the entirety of (a com	plete assignment from one of the joint inventors was made)					
the patent application/patent identified above by virtue of either:	,					
An assignment from the inventor(s) of the patent applica						
recorded in the United States Patent and Trademark Of Frame, or for which a copy thereof in						
OR	s attached.					
	n/patent identified above, to the current assignee as follows:					
S	To: Photobit Corporation					
The document was recorded in the United State						
	, or for which a copy thereof is attached.					
2. From: Photobit Corporation						
The document was recorded in the United State						
	, or for which a copy thereof is attached.					
From: Micron Technology, Inc.  The decument was recorded in the United State						
The document was recorded in the United States Patent and Trademark Office at  Reel , Frame , or for which a copy thereof is attached.						
, riante	, or for willout a dopy trial correction					
Additional documents in the chain of title are listed on a supplemental sheet(s).						
x As required by 37 CFR 3.73(b)(1)(i), the documentary evidence of the chain of title from the original owner to the assignee was, or concurrently is being, submitted for recordation pursuant to 37 CFR 3.11.						
[NOTE: A separate copy (i.e., a true copy of the original assignment document(s)) must be submitted to Assignment Division in accordance with 37 CFR Part 3, to record the assignment in the records of the USPTO. See MPEP 302.08]						
The undersigned (whose title is supplied below) is authorized to act of	n hehalf of the assignee.					
The undersigned (whose the island) is authorized to act of	February 23, 2009					
Signature	Date					
•	Atternation for Assigned					
Gianni Minutoli Printed or Typed Name	Attorney for Assignee					
Times of Types realis						

#### PATENT ASSIGNMENT AGREEMENT

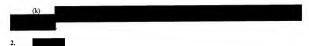
### 1. Definitions

- (a) "Agreement" shall mean this Patent Assignment Agreement.
- (b) "Assignee" shall mean Aptina Imaging Corporation, a Cayman Islands corporation with offices at c/o Citco Trustees (Cayman) Limited, Regatta Office Park, West Bay Road, Grand Cayman, Y1-1205, Cayman Islands.
- (c) "Assignor" shall mean Micron Technology, Inc., a Delaware corporation with offices at 8000 South Federal Way, Boise, ID 83707.
  - (d) "Effective Date" shall mean October 3, 2008.



- (g) "Imaging Patents" shall mean those patents identified in ATTACHMENT "A" hereto, including, without limitation, all divisions, continuations, continuations-in-part, reissues, reexaminations, and all foreign counterparts thereof, and which may issue thereon or in connection therewith after the Effective Date of this Agreement.
- (h) "Imaging Patent Applications" shall mean those filed patent applications identified in ATTACHMENT "B" hereto, including, without limitation, all patents, divisions, continuations, continuations-in-part, reissues, reexaminations, and all foreign counterparts which may issue thereon or in connection therewith after the Effective Date of this Agreement.
- (i) "Semiconductor Patents" shall mean those patents identified in ATTACHMENT "D" hereto, including, without limitation, all divisions, continuations, continuations-in-part, reissues, reexaminations, and all foreign counterparts thereof, and which may issue thereon or in connection therewith after the Effective Date of this Agreement.

(j) "Semiconductor Patent Applications" shall mean those filed patent applications identified in ATTACHMENT "E" hereto, including, without limitation, all patents, divisions, continuations, continuations-in-part, reissues, reexaminations, and all foreign counterparts which may issue thereon or in connection therewith after the Effective Date of this Agreement.



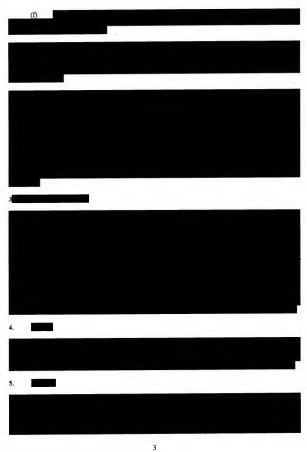
- (a) Subject to the terms and conditions of this Agreement, and subject to the rights of others existing as of the Effective Date of this Agreement if any, Assignor, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, hereby sells, assigns, and transfers to Assignee its entire right, title and interest in and to the Imaging Patents, including all rights to causes of action and remedies related thereto (including the right to sue for past, present or future infringement of rights related to the foregoing and the right to collect damages therefor). Assignor hereby authorizes and requests the Commissioner of Patents of the United States, and any other official of the United States whose duty it is to issue or record patents, to issue the Imaging Patents to Assignee and to record assignment of the Imaging Patents to Assignee.
- (b) Subject to the terms and conditions of this Agreement, and subject to the rights of others existing as of the Effective Date of this Agreement if any, Assignor, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, hereby sells, assigns, and transfers to Assignee its entire right, title and interest in and to the Intellectual Property rights in the Imaging Patent Applications. Assignor hereby authorizes and requests the Commissioner of Patents of the United States, and any other official of the United States and any country foreign to the United States whose duty it is to issue or record patents, to record assignment of the Imaging Patent Applications to Assignee.

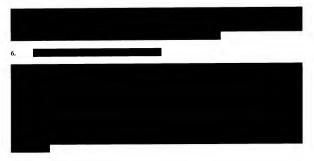


- (d) Subject to the terms and conditions of this Agreement, and subject to the rights of others existing as of the Effective Date of this Agreement if any, and subject further to the restrictions on the Semiconductor Patents set out below, Assignor, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, hereby sells, assigns, and transfers to Assignee its entire right, title and interest in and to the Semiconductor Patents, including all rights to causes of action are rendedes related thereto (including the right to sue for past, present or future infringement of rights related to the foregoing and the right to collect damages therefor). Assigner hereby authorizes and requests the Commissioner of Patents of the United States, and any other official of the United States and any country foreign to the United States whose duty it is to issue or record patents, to issue the Semiconductor Patents to Assignee and to record assignment of the Semiconductor Patents to Assignee.
- existing as of the Effective Date of this Agreement if any,

  Assignor, for good and valuable consideration, the
  receipt and sufficiency of which is hereby acknowledged, hereby sells, assigns, and transfers to Assignee
  its entire right, title and interest in and to the Intellectual Property rights in the Semiconductor Patent
  Applications. Assignor hereby authorizes and requests the Commissioner of Patents of the United States,
  and any other official of the United States and any country foreign to the United States whose duty it is to
  issue or record patents, to record assignment of the Semiconductor Patent Applications to Assignee.

Subject to the terms and conditions of this Agreement, and subject to the rights of others





## 7. General

This Agreement shall be effective as of the Effective Date hereof and shall be binding on the respective heirs, assigns, representatives, and successors of Assignor and of Assignee.

[the rest of this page intentionally left blank]

	Agreed t	o by:	
	Micron	Technology, Inc.	
	Signed:	the Color	
	Date:	2/10/as	, 2008
Notarization State of Idaho Country of Ada On 446/02, before me, Could be leave sample say	_, persona	lly appeared the above-named <b>Skrin b</b>	Appleton
who executed this Assignment in my presence and ack authorized capacity for the purposes set forth herein.		gned:	nd in his
REVIEWED MTI LEGAL	M	commission expires: \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
C. Samura R. S.	Agreed t	to by:	
Notarization	Aptina l Signed: Date:	Imaging Corporation  Norway I- Lows fe -  9/26/09	, 2008
State of Idaho County of Ada			
On 9/26/08, before me, Paula R. Spans	_, persona	lly appeared the above-named Threes L	eur, Ir.
who executed this Assignment in my presence and ack authorized capacity for the purposes set forth herein.	nowledged Si	/ \	

[Signature page to the Patent Assignment Agreement]

# ATTACHMENT "A"

## IMAGING PATENTS

## Aptina Issued

PATENT NUVBER	FILL NUMBER	TITLE	COUNTRY NAME	USSUE DATE
6905011	2002-1310.00AUS	MICRO LENSES AND METHOD FOR INCREASING AREA COVERAGE AND CONTROLLING SHAPE OF MICRO LENSES	United States of America	Feb 7, 2006
7001796	2002-1008.00/US +	TOTALINGENAL REFLECTION	United States of America	Feb 21,/2006
7002231	2004-0067.00/US	BARIER REGIONS FOR IMAGE SENSORS	United States of America	Feb 21, 2006
7002828	PBIT-0037.00/US	ANALOG TO DIGITAL CONVERTER.	United States of America	Feb 21, 2006
7005628	PBIT-0146.00/US	AMPLIFIER WITH VARIABLE SIGNAL GAIN AND MATCHED GAIN BANDWIDTH	United States of America	Feb 28, 2006
7008816	2003-0194.01005	MAGER PHOTOTOLOGE, CAPACITOR STRUCTURE WITH REDUCED PROCESS VARIATION	United States of America	Mar 1, 2008
7009227	2002-1143.00/US	SENSITIVITY PHOTODIODE STRUCTURE AND IMAGE PIXEL STRUCTURE	United States of America	Mar 7, 2006
7003646	PBIT-0020.00/US	Three-sided tutable CMOS Image Chip	. United States of America	Mar 7, 2006
7012557	2004-0332.00/US	RAMP MODULATION ADC FOR	United States of America	Mar 14, 2006
7012845	FBIT-0095 00/US	CIDCUITOWAND NATURE	United States of America	Mar 44, 2006
7012754	2004-0213.00/US	PHOTOSENSOR #  APPARATUS AND METHOD FOR MANUFACTURING TILTED MICROLENSES	United States of America	Mer 14, 2006
7013044	PB/T-0129 01/US	IMAGE SENSING SYSTEM WITH HISTOGRAM MODIFICATION	United States of America	Mar 14, 2006
7015448	2002-0306,00/US	DARK CURRENT REDUCTION CIRCUITRY FOR CMOS ACTIVE PIXEL SENSORS	United States of America	Mar 21, 2006
701584	2003-0820.00Us	MINIMIZED SAR-TYPE COLUMN WIDE ADD FOR MAGE SENSORS	United States of America	Mar 21, 2008
7015961	AVGO-0048.00U8	DIGITAL IMAGE SYSTEM AND METHOD FOR COMBINING DEMOSAICING AND BAD PIXEL	United States of America	Mar 21, 2006